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12/223958

LAP05 Rec'd PCT 13 AUG 2008

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To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of Conveying Party(ies):

(1) HITOSHI ISHII
(2) SEIICHI IBE
(3) TADAYOSHI ITOH
(4) SHIGEYOSHI NAKAKI

2. Name and Address of Receiving Party(ies):

Name: **Kureha Corporation**
Address: 3-3-2 Nihonbashi-Hamacho,
City: Chuo-ku, Tokyo 103-8552
Japan

Additional names of conveying parties attached: ☐ Yes ☒ No

3. Nature of Conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other:

Execution Date: (1) and (4) July 15, 2008;
(2) and (3) July 14, 2008

4. (a) Patent Application Number(s):

If this document is being filed together with a new application,
the execution date of the application is:

☐ Additional Numbers Attached.

4. (b) Patent Numbers:

5. Name and Address of Party to whom Correspondence
Concerning this Document Should be Mailed:

Name: **Stanley P. Fisher**

Address: **Reed Smith LLP**
3110 Fairview Park Dr.
Suite 1400
Falls Church, Va. 22042

6. Total Number of Applications and Patents Involved: 1

7. Total Fee: **\$40.00**
(37 C.F.R. § 3.41)

☒ Enclosed.
☒ Authorized to be charged to deposit account.

8. Deposit Account Number: 08-1480

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9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Stanley P. Fisher, Registration No. 24, 344

[Signature] August 13, 2008
Juan Carlos A. Marquez, Registration No. 34,072

Total number of pages comprising cover sheet: 1

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PATENT
REEL: 021415 FRAME: 0405

ASSIGNMENT

WHEREAS, Hitoshi ISHII, Seiichi IBE, Tadayoshi ITOH and Shigeyoshi NAKAKI, whose post office address(es) appear below hereinafter referred to as ASSIGNOR, have invented certain new and useful improvements in a HEAT SHRINKABLE MULTILAYER FILM AND PACKAGING MATERIAL USING THE SAME (hereinafter referred to as THE INVENTION) for which an application for United States Letters Patent was filed on _____, Application Number _____, or is being filed herewith;

WHEREAS, Kureha Corporation, whose post office address is 3-3-2, Nihonbashi-Hamacho, Chuo-ku, Tokyo 103-8552 Japan (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Name: Hitoshi ISHII
Address: c/o Kureha Plastics Corporation,
2221, Kamitamari, Omitama-shi,
Ibaraki 311-3493 Japan

Hitoshi Ishii
Signature
July 15th, 2008
Date

Name: Seiichi IBE
Address: c/o Polymer Processing & Products
Research Laboratories, Kureha Corporation,
18-13, Kamitamari, Omitama-shi,
Ibaraki 311-3436 Japan

Seiichi Ibe
Signature
July 14th, 2008
Date

Name: Tadayoshi ITOH
Address: c/o Polymer Processing & Products
Research Laboratories, Kureha Corporation,
18-13, Kamitamari, Omitama-shi,
Ibaraki 311-3436 Japan

Tadayoshi Ito
Signature
July 14th, 2008
Date

Name: Shigeyoshi NAKAKI
Address: c/o Kureha Plastics Corporation,
2221, Kamitamari, Omitama-shi,
Ibaraki 311-3493 Japan

Shigeyoshi Nakaki
Signature
July 15th, 2008
Date